TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

## TC74AC393P, TC74AC393F, TC74AC393FT

#### **Dual Binary Counter**

The TC74AC393 is an advanced high speed CMOS 4-BIT BINARY COUNTER fabricated with silicon gate and double-layer metal wiring  $C^2MOS$  technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

It contains two independent counter circuits in one package, so that counting or frequency division of eight binary bits can be achieved with one IC.

This device changes state on the negative going transition of the  $\overline{\text{CLOCK}}$  pulse. The counter can be reset to "0" (QA to QD = "L") by a high at the CLEAR input regardless of other inputs.

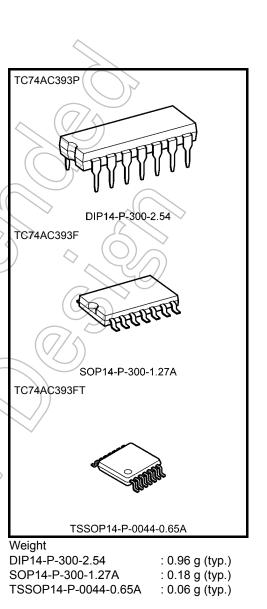
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### Features

- High speed:  $f_{max} = 180 \text{ MHz}$  (typ.) at  $V_{CC} = 5 \text{ V}$
- Low power dissipation:  $I_{CC} = 8 \mu A (max)$  at  $Ta = 25^{\circ}C$
- High noise immunity:  $V_{\text{NIH}} = V_{\text{NIL}} = 28\% V_{\text{CC}}$  (min)
- Symmetrical output impedance:  $|I_{OH}| = I_{OL} = 24$  mA (min)

Capability of driving 50  $\Omega$  transmission lines.

- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 5.5 V
- Pin and function compatible with 74F393



<u>(3)</u> 1QA

<u>(4)</u> 1QB

<u>(5)</u> 1QC

<u>(6)</u> 1QD

<u>(11)</u> 2QA

<u>(10)</u> 2QB

<u>(9)</u> 2QC

<u>(8)</u> 2QD

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## **Pin Assignment**

## **IEC Logic Symbol**

1CLR (2)

1<del>CK \_\_\_\_\_</del>

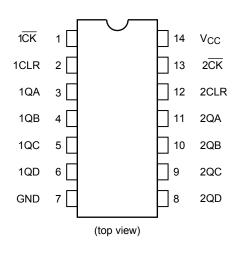
2CLR (12)

2<del>CK</del> <u>(13)</u>

 $\frac{\text{CTRDIV 16}}{\text{CT}=0} 0$ 

СТ

3

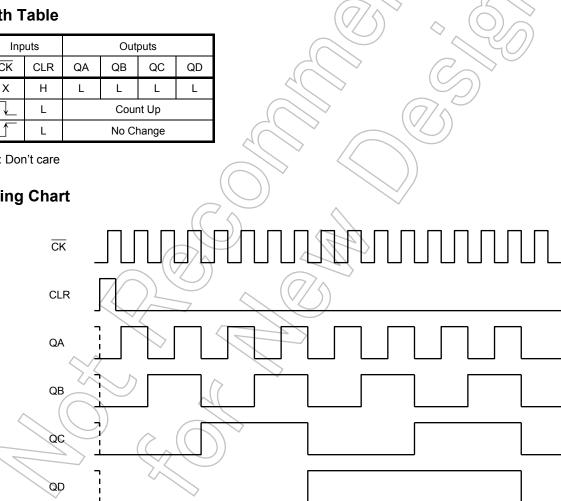


## **Truth Table**

Inp	uts	Outputs						
СК	CLR	QA	QB	QC	QD			
Х	Н	L	L	L	L			
$\neg$	L	Count Up						
	L	No Change						

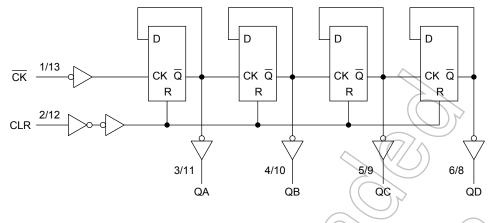
X: Don't care

## **Timing Chart**



## <u>TOSHIBA</u>

## System Diagram



### Absolute Maximum Ratings (Note 1)

			15
Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V)
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	X V
DC output voltage	Vout	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	lıк	±20	mA
Output diode current	I <sub>OK</sub>	±50 (// 5)	mA
DC output current	Ιουτ	±50	mA
DC V <sub>CC</sub> /ground current	Icc	±200	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP/TSSOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = −40 to 65°C. From Ta = 65 to 85°C, a derating factor of −10 mW/°C should be applied up to 300 mW.

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0 to 5.5	V	
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V	
Output voltage	V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40 to 85	°C	
Input rise and fall time	dt/dV	0 to 100 (V <sub>CC</sub> = 3.3 ± 0.3 V)	ns/V	
	uvuv	0 to 20 (V <sub>CC</sub> = 5 $\pm$ 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

## **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Characteristics Symbol Test Condition			Ta = 25°C			Ta = −40 to 85°C		Unit		
Onaracteristics			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Onic		
				2.0	1.50	_	X	1.50	_		
High-level input voltage	VIH		—	3.0	2.10	—	F	2.10	—	V	
				5.5	3.85	_	$\langle \cdot \rangle$	3.85	_		
				2.0	>1	+0	0.50	-	0.50		
Low-level input voltage	VIL		_		_		0.90	—	0.90	V	
Ŭ				5.5	-(		1.65	—	1.65		
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	_	1.9	—		
			I <sub>OH</sub> = −50 μA	3.0	2.9	3.0	—	2.9			
High-level output				4.5	4.4	4.5	_	4.4	$\searrow$	v	
voltage			I <sub>OH</sub> = −4 mA	3.0	2.58	—	-6	2.48	> -	v	
			I <sub>OH</sub> = −24 mA	4.5	3.94	$-\Diamond$		3.80	) —		
			I <sub>OH</sub> = −75 mA (Note)	5.5	_	-	X	3.85			
	V <sub>OL</sub> =	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	—	0.0	0.1	~_	0.1		
			I <sub>OL</sub> = 50 μA	3.0	—	0.0	0,1	—	0.1		
Low-level output				4.5	—	0.0	0.1	—	0.1	V	
voltage			I <sub>OL</sub> = 12 mA	3.0		Ľ	0.36	—	0.44	·	
			I <sub>OL</sub> = 24 mA	4.5	_	-	0.36	—	0.44		
			I <sub>OL</sub> = 75 mA (Note)	5.5	/	))—	—	—	1.65		
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5		_	±0.1	_	±1.0	μA	
Quiescent supply current	ICC	VIN = V <sub>CC</sub> or GND		5.5	_	_	8.0	_	80.0	μA	

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

## Timing Requirements (input: $t_r = t_f = 3 \text{ ns}$ )

Characteristics	Symbol		Test Condition		Ta = 25°C	Ta = −40 to 85°C	Unit
				V <sub>CC</sub> (V)	Limit	Limit	
Minimum pulse width	t <sub>w (H)</sub>			3.3 ± 0.3	7.0	7.0	20
(CK)	tw (L)	7	—	$5.0 \pm 0.5$	5.0	5.0	ns
Minimum pulse width				$3.3 \pm 0.3$	7.0	7.0	ns
(CLR)	t <sub>w (H)</sub>		—	$5.0 \pm 0.5$	5.0	5.0	115
Minimum removal time	·			$3.3 \pm 0.3$	6.0	6.0	20
	t <sub>rem</sub>		—	$5.0 \pm 0.5$	3.0	3.0	ns

## AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Characteristics	Symbol Test Condition		Ta = 25°C			Ta = −40 to 85°C		Unit	
			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
Propagation delay time	t <sub>pLH</sub>	_	3.3 ± 0.3	_	8.0	13.2	1.0	15.0	ns
( <del>CK</del> - QA )	t <sub>pHL</sub>		5.0 ± 0.5	—	5.0 <	8.3	1.0	9.5	
Propagation delay time	t <sub>pLH</sub>	_	3.3 ± 0.3	_	10.1	16.7	1.0	19.0	ns
( <del>CK</del> - QB )	t <sub>pHL</sub>		5.0 ± 0.5	—	5.9	10.5	1.0	12.0	
Propagation delay time	t <sub>pLH</sub>	_	3.3 ± 0.3	_	12.0	20.2	1.0	23.0	ns
( <del>CK</del> - QC )	tpHL		5.0 ± 0.5	-((	6.8	12.3	1.0	14.0	_
Propagation delay time	t <sub>pLH</sub>	_	3.3 ± 0.3		13.0	23.0	1.0	26.0	ns
( <del>CK</del> - QD )	tpHL		5.0 ± 0.5 <		7.5	13.2	40	15,0	
Propagation delay time	t <sub>o</sub> HL	_	3.3 ± 0.3	75	8.0	13.2	1.0	15.0	ns
(CLR-Q <sub>n</sub> )	r		5.0 ± 0.5	Ì	5.1	8.8	(1.9)	) 10.0	
Maximum clock	f <sub>max</sub>	_ (	3.3 ± 0.3	65	125		65	_	MHz
frequency	max	40	5.0 ± 0.5	100	160	$\langle \gamma \rangle$	100		
Input capacitance	C <sub>IN</sub>	7	$\searrow$	—	5	(10/	—	10	pF
Power dissipation capacitance	C <sub>PD</sub>		(Note)		36	) –	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

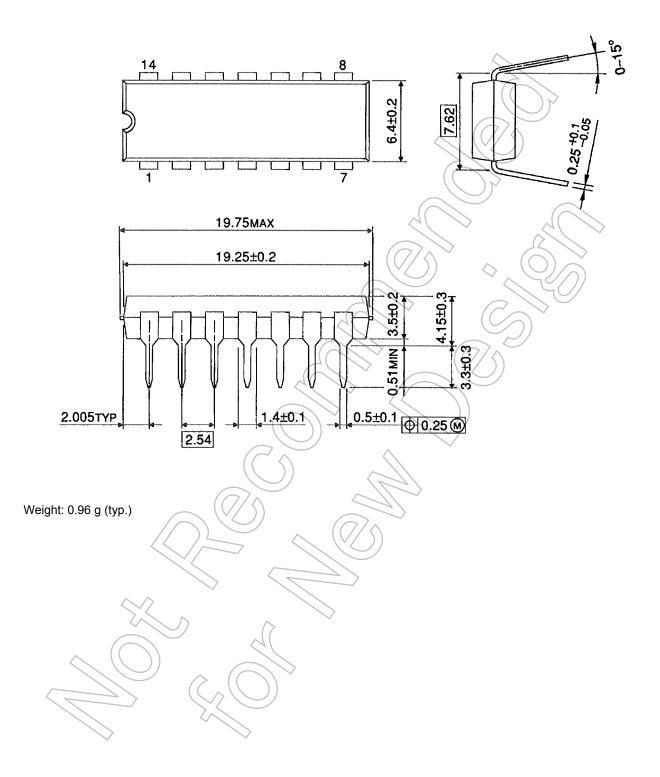
Average operating current can be obtained by the equation:

 $I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$  (per counter)

#### **Package Dimensions**

DIP14-P-300-2.54

Unit : mm

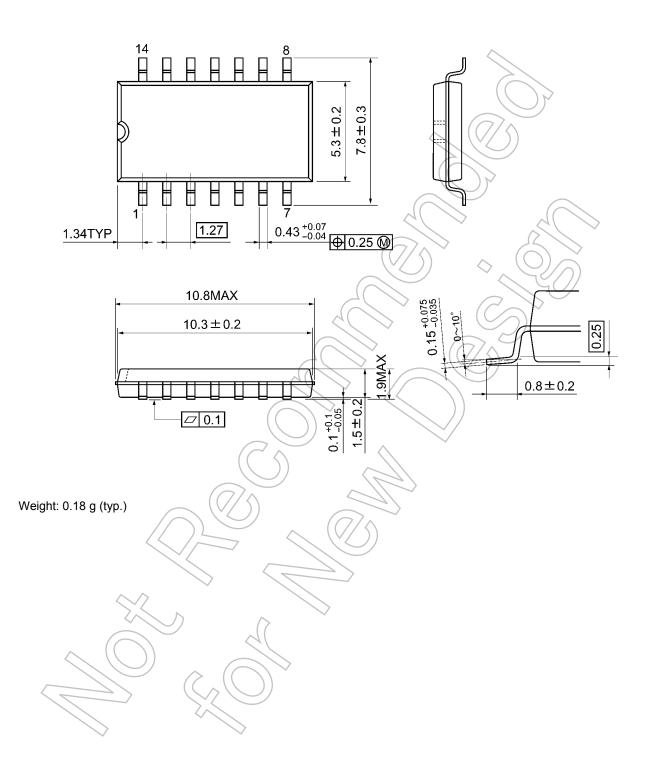




### **Package Dimensions**

SOP14-P-300-1.27A

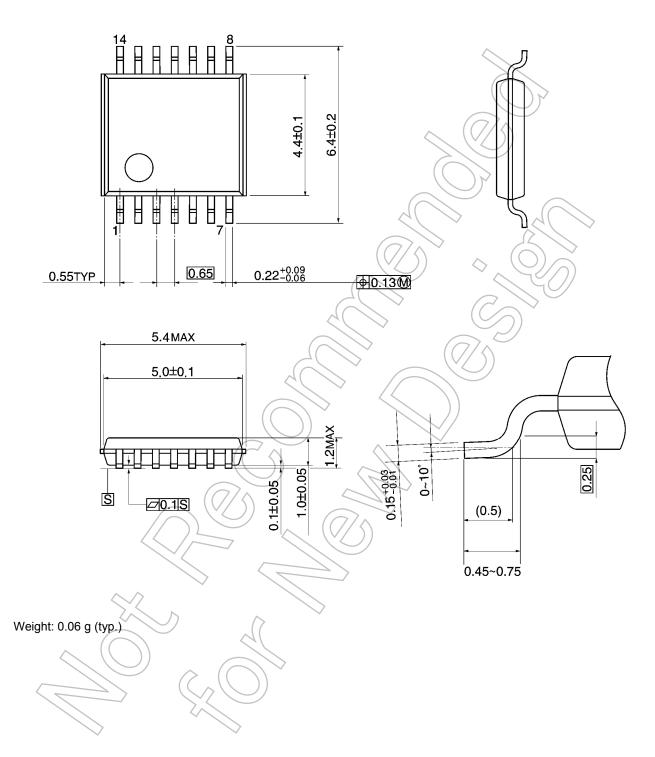
Unit: mm



## Package Dimensions

TSSOP14-P-0044-0.65A

Unit: mm



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